## Docket Number (Optional) **DECLARATION FOR PATENT APPLICATION** MR2561-144 As a below named inventor, I hereby declare that My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is tisted below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled An Improved Thermal Module the specification , the specification of which is attached hereto unless the following box is checked: as United States Application Number or PCT International Application was filed on \_\_\_ and was amended on \_\_ (if applicable). Number I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. Lacknowledge the duty to disclose information which is material to patentability as defined in 37 CFR §1.56. I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent I nereby claim foreign printy benefits under 35 d.3.5. 9 Hatalitof by 3 d.5.4 by the state of th certificate, or PCT International application having a filing date before that of the application on which priority is claimed. Priority Not Claimed Prior Foreign Application(s) (Day/Month/Year Filed) (Number) (Country) (Day/Month/Year Filed) (Number) (Country) Thereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below. (Application Number) (Filing Date) (Application Number) I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application. (Application Number) (Filing Date) (Status-patented, pending, abandoned) (Filing Date) (Stalus-patented, pending, abandoned) (Application Number) I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application in the Patent Herina and Trademark Office connected therewith: Morton J. Rosenberg, #26,049; David I. Klein, #33, Jun Y. Lee, #40,262; Harry L. Sernaker, #50,595; David R. Wood, #53,868 Address all telephone calls to 410-465-6678 #33,253; Address all correspondence to Rosenberg, Klein & Lee 3458 Ellicott Center Drive-Suite 101 Ellicott City, MD 21043 I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and the like so made are punishable by tine or imprisonment, or both, under section 1001 of little 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. Full name of sole or first inventor (given name, tamily name) Chui-Kai PENG (PENG IS FAMILY NAME) Inventor's signature Chui-Kai Pang Oate Citizenship Mailing Address FF-1, NO.33, Dane 200, Pao Shan Rd., Hsin Chu City,

Date

Full name of second joint inventor, if any

Additional Inventors are being named on separately numbered sheets attached hereto.

Second Inventor's signature

Citizenship \_\_\_\_ Mailing Address